

## N-channel 650 V, 0.024 $\Omega$ typ., 84 A, MDmesh™ M5 Power MOSFET in a TO247-4 package

Datasheet — production data

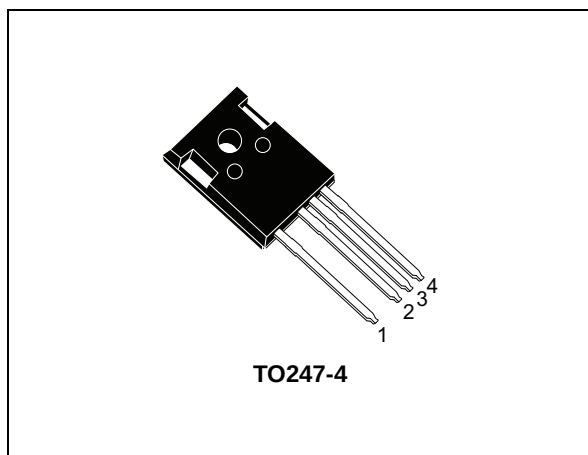
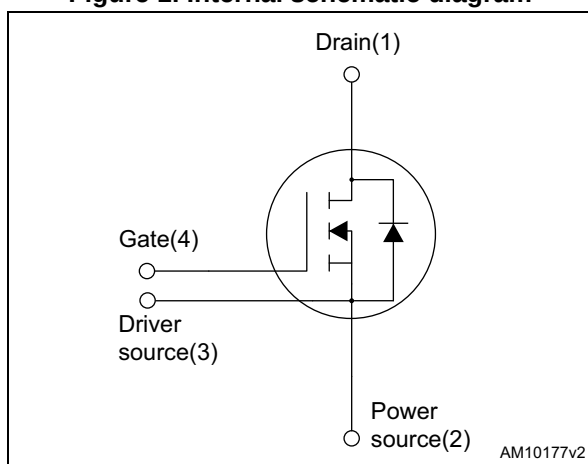


Figure 1. Internal schematic diagram



### Features

| Order code   | $V_{DS}$<br>@ $T_{jmax.}$ | $R_{DS(on)}$ max. | $I_D$ |
|--------------|---------------------------|-------------------|-------|
| STW88N65M5-4 | 710 V                     | 0.029 $\Omega$    | 84 A  |

- Higher  $V_{DS}$  rating
- Higher dv/dt capability
- Excellent switching performance thanks to the extra driving source pin
- Easy to drive
- 100% avalanche tested

### Applications

- High efficiency switching applications:
  - Servers
  - PV inverters
  - Telecom infrastructure
  - Multi kW battery chargers

### Description

This device is an N-channel Power MOSFET based on MDmesh™ M5 innovative vertical process technology combined with the well-known PowerMESH™ horizontal layout. The resulting product offers extremely low on-resistance, making it particularly suitable for applications requiring high power and superior efficiency.

Table 1. Device summary

| Order code   | Marking | Package | Packing |
|--------------|---------|---------|---------|
| STW88N65M5-4 | 88N65M5 | TO247-4 | Tube    |

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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

| Symbol         | Parameter                                                                                                              | Value       | Unit               |
|----------------|------------------------------------------------------------------------------------------------------------------------|-------------|--------------------|
| $V_{GS}$       | Gate- source voltage                                                                                                   | $\pm 25$    | V                  |
| $I_D$          | Drain current (continuous) at $T_C = 25\text{ }^{\circ}\text{C}$                                                       | 84          | A                  |
|                | Drain current (continuous) at $T_C = 100\text{ }^{\circ}\text{C}$                                                      | 50.5        |                    |
| $I_{DM}^{(1)}$ | Drain current (pulsed)                                                                                                 | 336         | A                  |
| $P_{TOT}$      | Total dissipation at $T_C = 25\text{ }^{\circ}\text{C}$                                                                | 450         | W                  |
| $I_{AR}$       | Max. current during repetitive or single pulse avalanche (pulse width limited by $T_{jmax}$ )                          | 15          | A                  |
| $E_{AS}$       | Single pulse avalanche energy (starting $T_j = 25\text{ }^{\circ}\text{C}$ , $I_D = I_{AR}$ , $V_{DD} = 50\text{ V}$ ) | 2000        | mJ                 |
| $dv/dt^{(2)}$  | Peak diode recovery voltage slope                                                                                      | 15          | V/ns               |
| $T_{stg}$      | Storage temperature                                                                                                    | - 55 to 150 | $^{\circ}\text{C}$ |
| $T_j$          | Max. operating junction temperature                                                                                    | 150         |                    |

1. Pulse width limited by safe operating area.

2.  $I_{SD} \leq 84\text{ A}$ ,  $di/dt = 400\text{ A}/\mu\text{s}$ , peak  $V_{DS} < V_{(BR)DSS}$ ,  $V_{DD} = 400\text{ V}$ .

**Table 3. Thermal data**

| Symbol         | Parameter                                | Value | Unit                        |
|----------------|------------------------------------------|-------|-----------------------------|
| $R_{thj-case}$ | Thermal resistance junction-case max.    | 0.28  | $^{\circ}\text{C}/\text{W}$ |
| $R_{thj-amb}$  | Thermal resistance junction-ambient max. | 50    |                             |

## 2 Electrical characteristics

( $T_C = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

**Table 4. Static**

| Symbol        | Parameter                         | Test conditions                                                                          | Min. | Typ.  | Max.      | Unit          |
|---------------|-----------------------------------|------------------------------------------------------------------------------------------|------|-------|-----------|---------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage    | $I_D = 1\text{ mA}$ , $V_{GS} = 0\text{ V}$                                              | 650  |       |           | V             |
| $I_{DSS}$     | Zero gate voltage drain current   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 650\text{ V}$                                          |      |       | 1         | $\mu\text{A}$ |
|               |                                   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 650\text{ V}$ ,<br>$T_C = 125\text{ }^{\circ}\text{C}$ |      |       | 100       |               |
| $I_{GSS}$     | Gate-body leakage current         | $V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 25\text{ V}$                                       |      |       | $\pm 100$ | nA            |
| $V_{GS(th)}$  | Gate threshold voltage            | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                       | 3    | 4     | 5         | V             |
| $R_{DS(on)}$  | Static drain-source on-resistance | $V_{GS} = 10\text{ V}$ , $I_D = 42\text{ A}$                                             |      | 0.024 | 0.029     | $\Omega$      |

**Table 5. Dynamic**

| Symbol            | Parameter                             | Test conditions                                                                                               | Min. | Typ. | Max. | Unit     |
|-------------------|---------------------------------------|---------------------------------------------------------------------------------------------------------------|------|------|------|----------|
| $C_{iss}$         | Input capacitance                     | $V_{DS} = 100\text{ V}$ , $f = 1\text{ MHz}$ ,<br>$V_{GS} = 0\text{ V}$                                       | -    | 8825 | -    | pF       |
| $C_{oss}$         | Output capacitance                    |                                                                                                               | -    | 223  | -    |          |
| $C_{rss}$         | Reverse transfer capacitance          |                                                                                                               | -    | 11   | -    |          |
| $C_{o(tr)}^{(1)}$ | Equivalent capacitance time related   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 0\text{ to }520\text{ V}$                                                   | -    | 778  | -    | pF       |
| $C_{o(er)}^{(2)}$ | Equivalent capacitance energy related |                                                                                                               | -    | 202  | -    |          |
| $R_G$             | Intrinsic gate resistance             | $f = 1\text{ MHz}$ open drain                                                                                 | -    | 1.79 | -    | $\Omega$ |
| $Q_g$             | Total gate charge                     | $V_{DD} = 520\text{ V}$ , $I_D = 42\text{ A}$ ,<br>$V_{GS} = 10\text{ V}$<br>(see <a href="#">Figure 16</a> ) | -    | 204  | -    | nC       |
| $Q_{gs}$          | Gate-source charge                    |                                                                                                               | -    | 51   | -    |          |
| $Q_{gd}$          | Gate-drain charge                     |                                                                                                               | -    | 84   | -    |          |

1.  $C_{o(tr)}$  is a constant capacitance value that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .
2.  $C_{o(er)}$  is a constant capacitance value that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

Table 6. Switching times

| Symbol       | Parameter          | Test conditions                                                                                                                                        | Min. | Typ. | Max. | Unit |
|--------------|--------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $t_{d(V)}$   | Voltage delay time | $V_{DD} = 400\text{ V}$ , $I_D = 56\text{ A}$<br>$R_G = 7.2\ \Omega$ $V_{GS} = 10\text{ V}$<br>(see <a href="#">Figure 17</a> and <a href="#">20</a> ) | -    | 150  | -    | ns   |
| $t_{r(V)}$   | Voltage rise time  |                                                                                                                                                        | -    | 19   | -    |      |
| $t_{f(i)}$   | Current fall time  |                                                                                                                                                        | -    | 24   | -    |      |
| $t_{c(off)}$ | Crossing time      |                                                                                                                                                        | -    | 45   | -    |      |

Table 7. Source-drain diode

| Symbol          | Parameter                     | Test conditions                                                                                                                                                   | Min. | Typ. | Max. | Unit          |
|-----------------|-------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|---------------|
| $I_{SD}$        | Source-drain current          |                                                                                                                                                                   | -    |      | 84   | A             |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |                                                                                                                                                                   | -    |      | 336  | A             |
| $V_{SD}^{(2)}$  | Forward on voltage            | $I_{SD} = 84\text{ A}$ , $V_{GS} = 0$                                                                                                                             | -    |      | 1.5  | V             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 84\text{ A}$ ,<br>$di/dt = 100\text{ A}/\mu\text{s}$<br>$V_{DD} = 100\text{ V}$ (see <a href="#">Figure 17</a> )                                        | -    | 544  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |                                                                                                                                                                   | -    | 14   |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |                                                                                                                                                                   | -    | 50   |      | A             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 84\text{ A}$ ,<br>$di/dt = 100\text{ A}/\mu\text{s}$<br>$V_{DD} = 100\text{ V}$ , $T_J = 150\text{ }^\circ\text{C}$<br>(see <a href="#">Figure 17</a> ) | -    | 660  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |                                                                                                                                                                   | -    | 20   |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |                                                                                                                                                                   | -    | 60   |      | A             |

1. Pulse width limited by safe operating area.
2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

## 2.1 Electrical characteristics (curves)

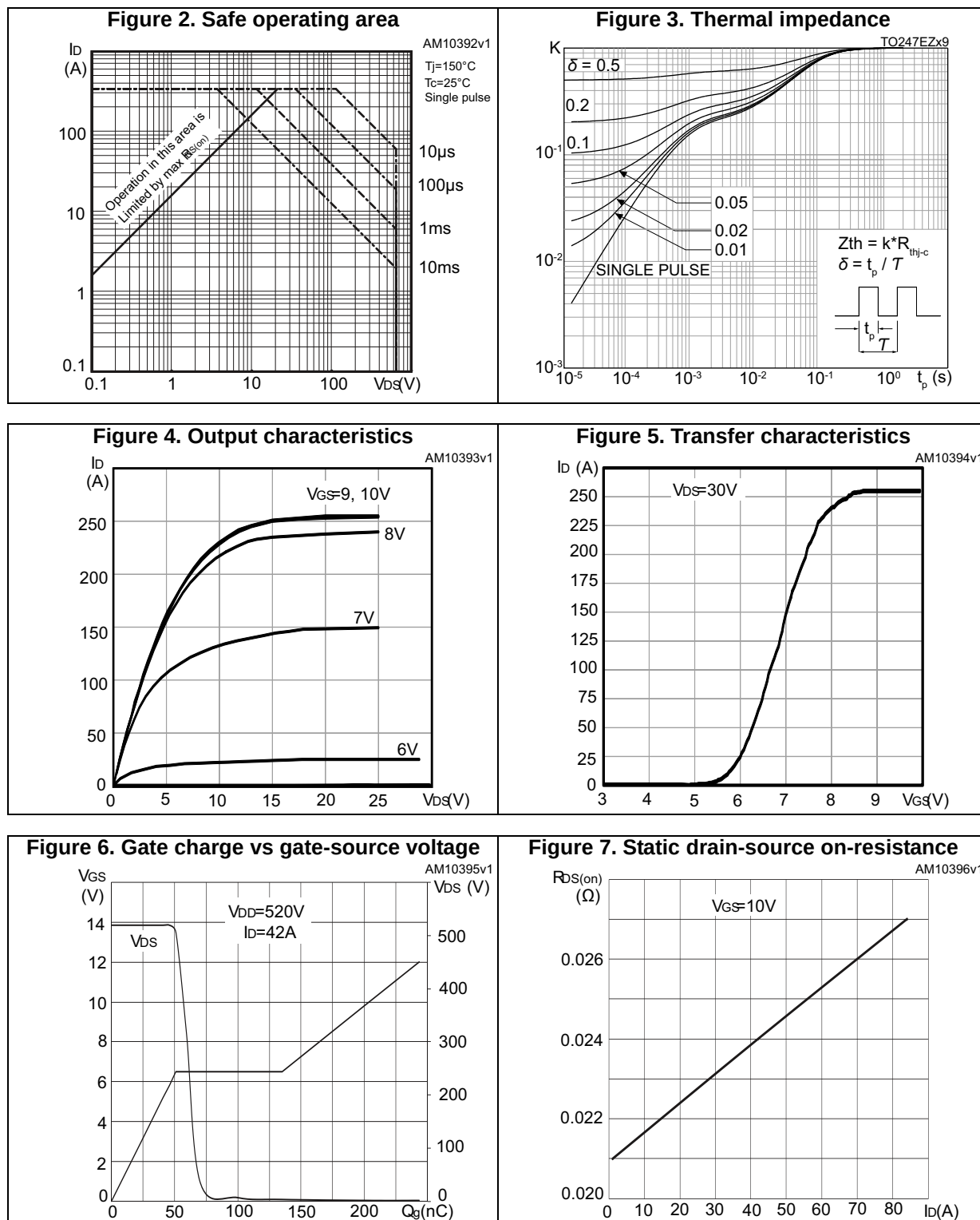


Figure 8. Capacitance variations

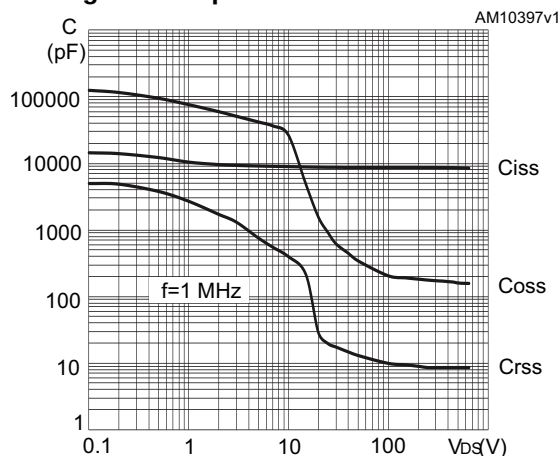


Figure 9. Output capacitance stored energy

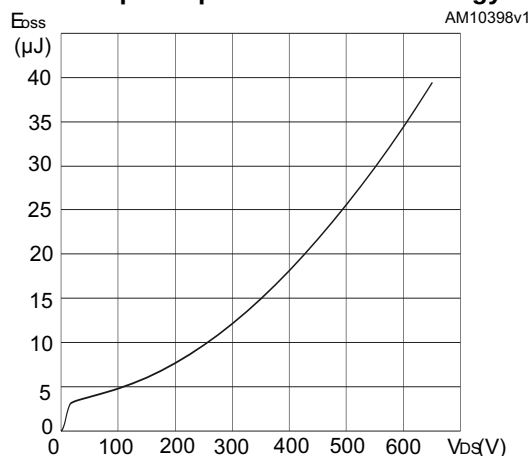


Figure 10. Normalized gate threshold voltage vs temperature

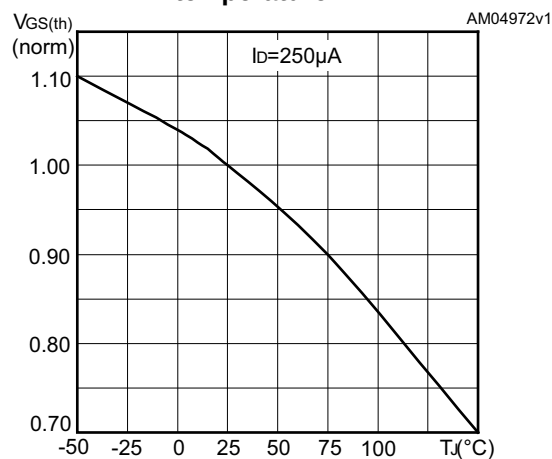


Figure 11. Normalized on-resistance vs temperature

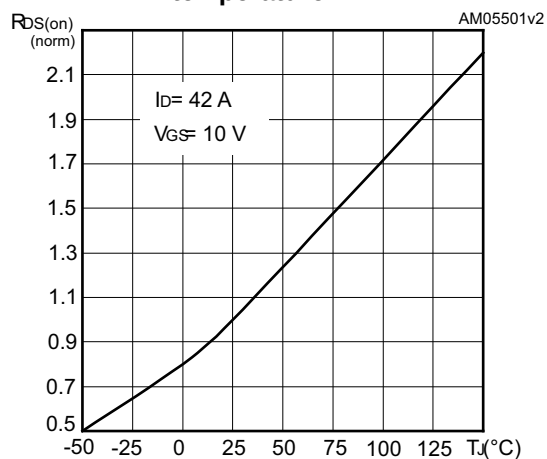
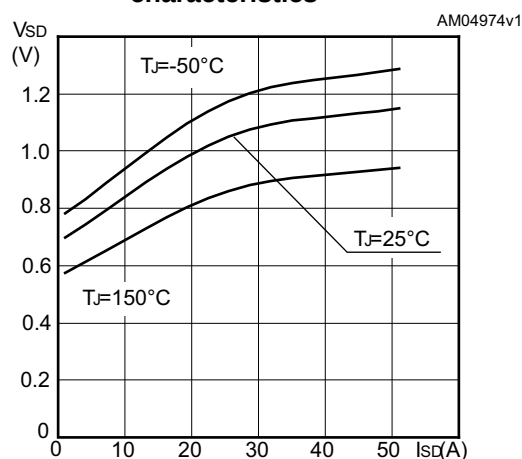
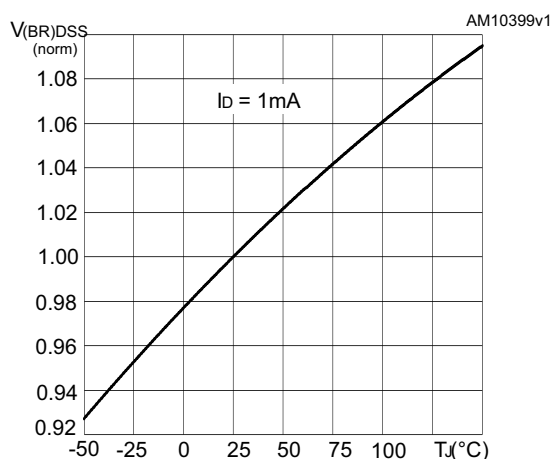
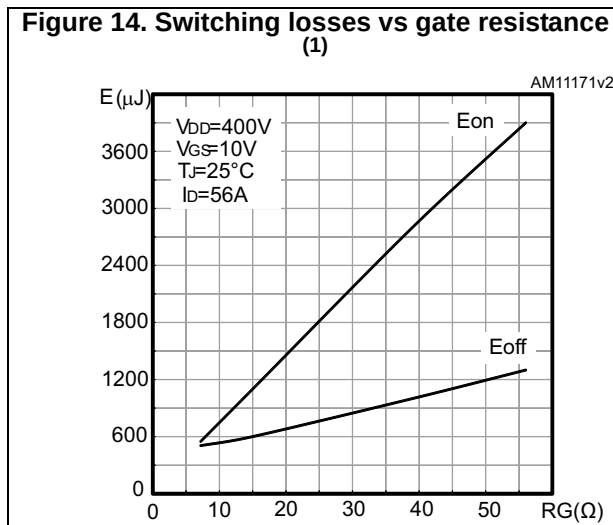


Figure 12. Source-drain diode forward characteristics

Figure 13. Normalized  $V_{(BR)DSS}$  vs temperature

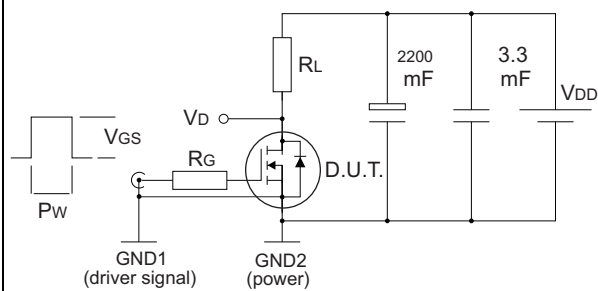
**Figure 14. Switching losses vs gate resistance**  
(1)

1.  $E_{on}$  including reverse recovery of a SiC diode.



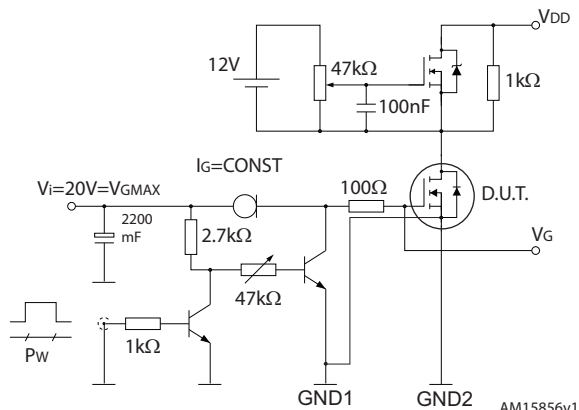
### 3 Test circuits

**Figure 15. Switching times test circuit for resistive load**



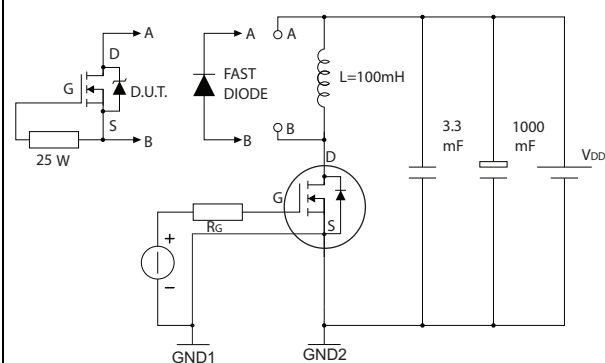
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**Figure 16. Gate charge test circuit**



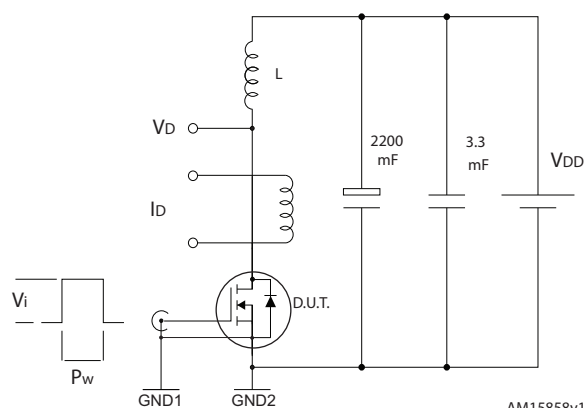
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**Figure 17. Test circuit for inductive load switching and diode recovery times**



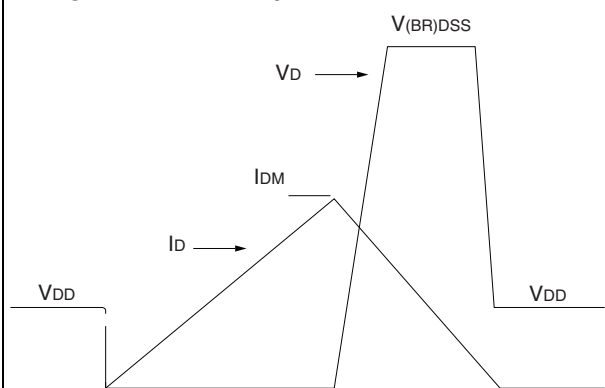
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**Figure 18. Unclamped inductive load test circuit**



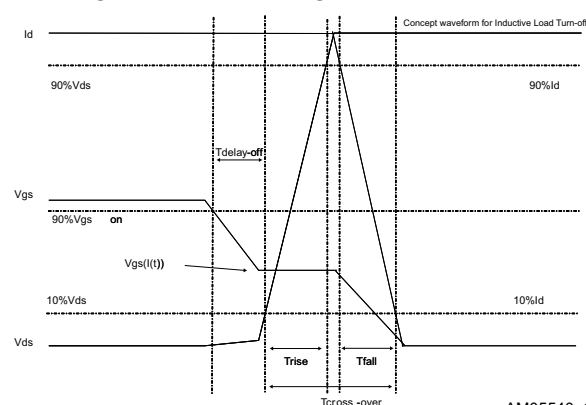
AM15858v1

**Figure 19. Unclamped inductive waveform**



AM01472v1

**Figure 20. Switching time waveform**



AM05540v1

## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

### 4.1 TO247-4 package information

Figure 21. TO247-4 package outline

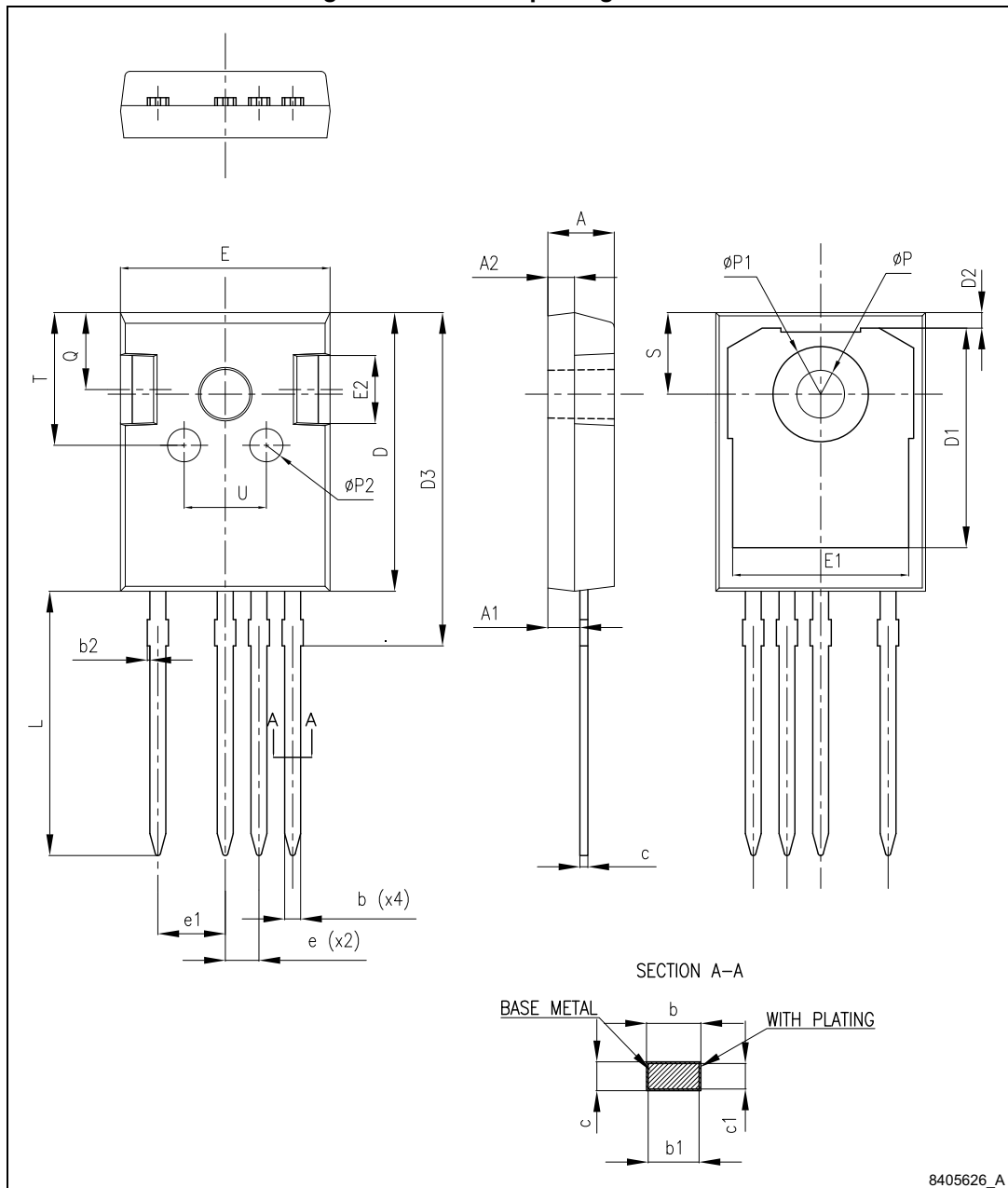


Table 8. TO247-4 package mechanical data

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 4.90  | 5.00  | 5.10  |
| A1   | 2.31  | 2.41  | 2.51  |
| A2   | 1.90  | 2.00  | 2.10  |
| b    | 1.16  |       | 1.29  |
| b1   | 1.15  | 1.20  | 1.25  |
| b2   | 0     |       | 0.20  |
| c    | 0.59  |       | 0.66  |
| c1   | 0.58  | 0.60  | 0.62  |
| D    | 20.90 | 21.00 | 21.10 |
| D1   | 16.25 | 16.55 | 16.85 |
| D2   | 1.05  | 1.20  | 1.35  |
| D3   | 24.97 | 25.12 | 25.27 |
| E    | 15.70 | 15.80 | 15.90 |
| E1   | 13.10 | 13.30 | 13.50 |
| E2   | 4.90  | 5.00  | 5.10  |
| E3   | 2.40  | 2.50  | 2.60  |
| e    | 2.44  | 2.54  | 2.64  |
| e1   | 4.98  | 5.08  | 5.18  |
| L    | 19.80 | 19.92 | 20.10 |
| P    | 3.50  | 3.60  | 3.70  |
| P1   |       |       | 7.40  |
| P2   | 2.40  | 2.50  | 2.60  |
| Q    | 5.60  |       | 6.00  |
| S    |       | 6.15  |       |
| T    | 9.80  |       | 10.20 |
| U    | 6.00  |       | 6.40  |

## 5 Revision history

**Table 9. Document revision history**

| Date        | Revision | Changes        |
|-------------|----------|----------------|
| 21-Oct-2015 | 1        | First release. |

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